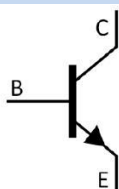


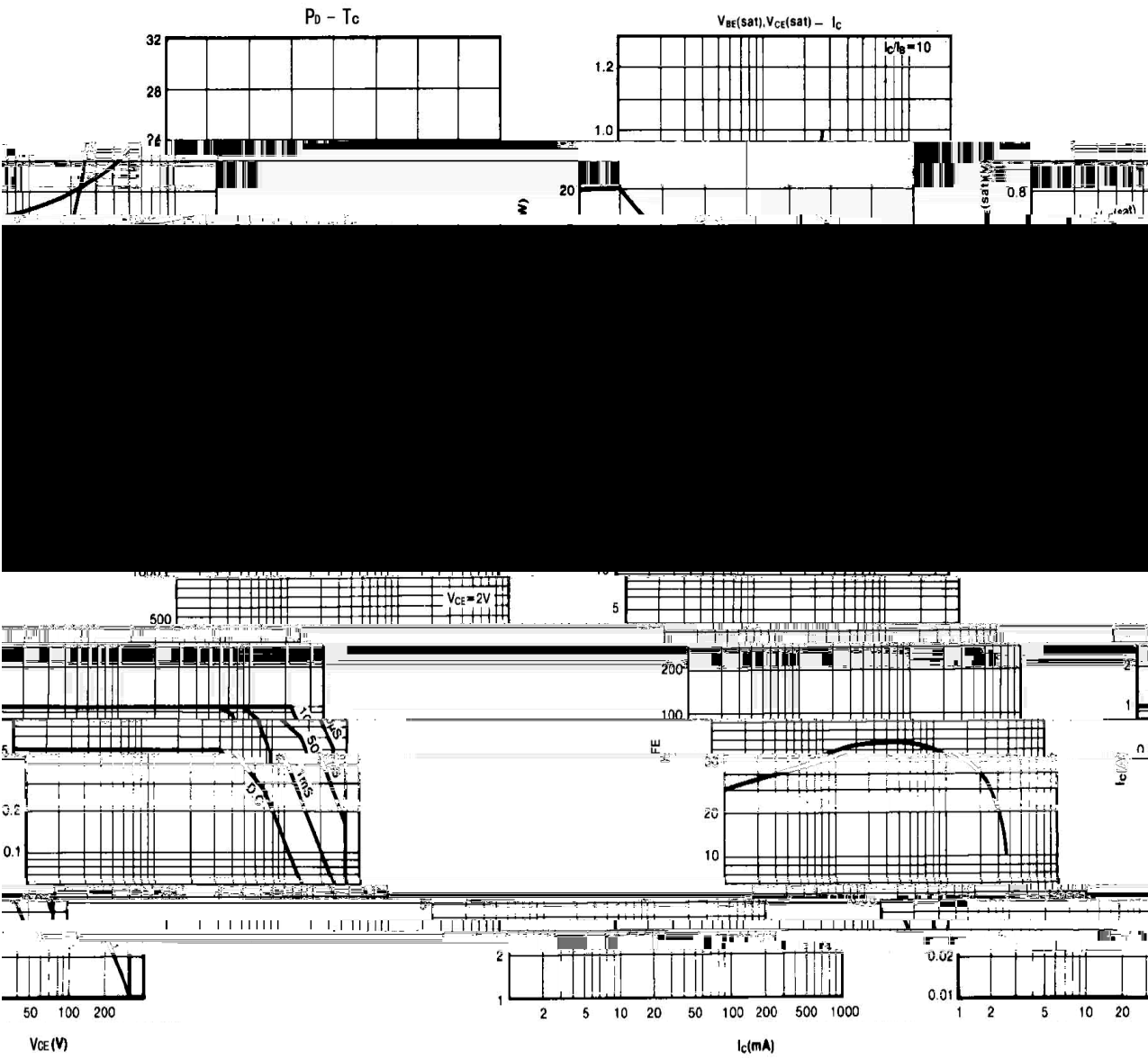
/ Descriptions**/ Features****/ Applications****/ Equivalent Circuit****/ Pinning****/ h_{FE} Classifications & Marking**

/ Absolute Maximum Ratings(Ta=25)

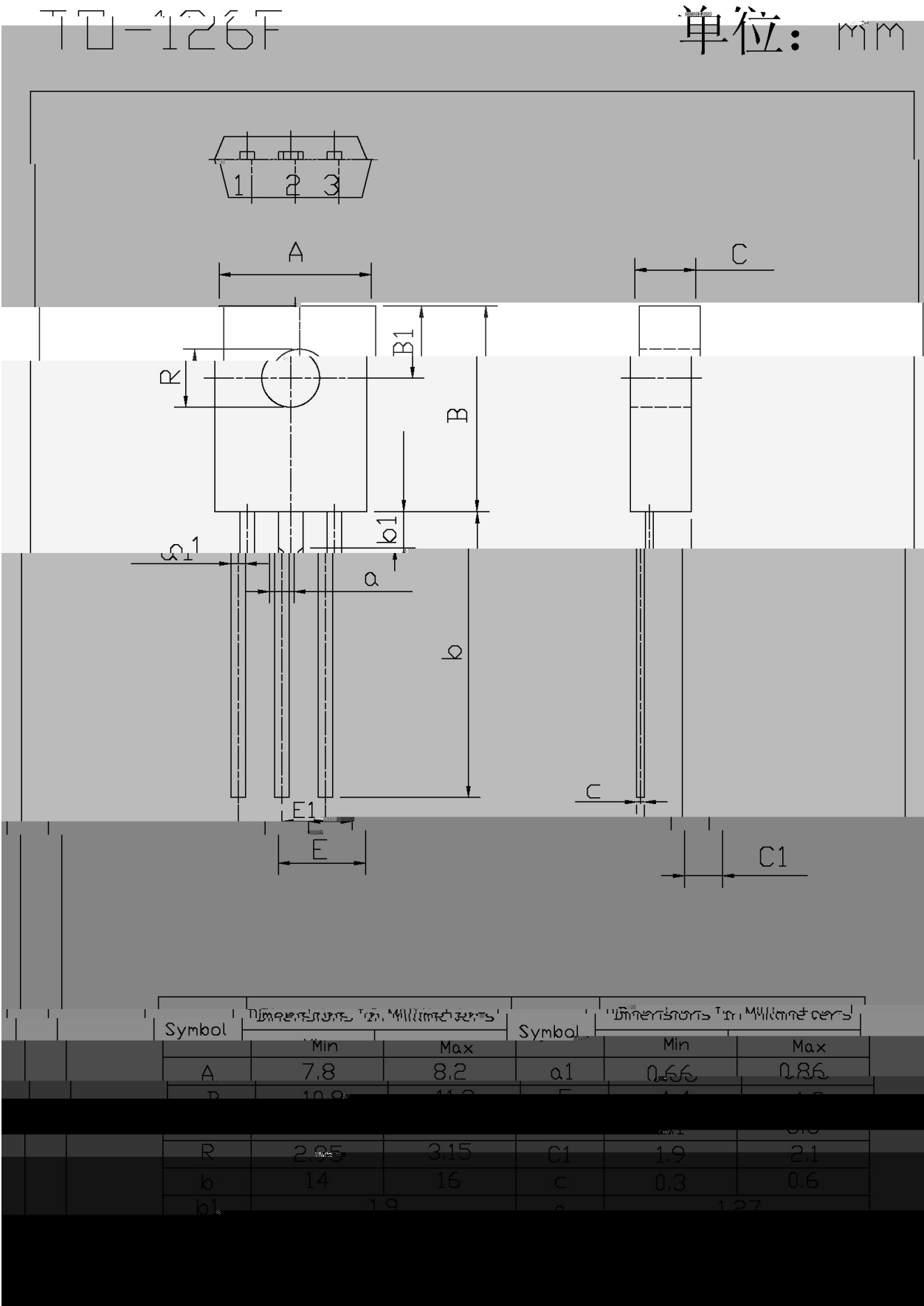
/ Electrical Characteristics(Ta=25)

						μ
						μ

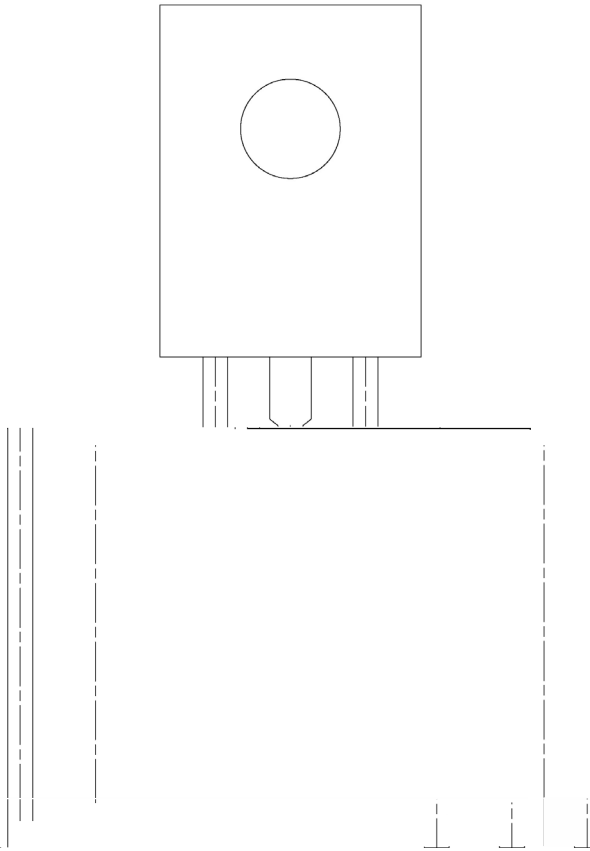
/ Electrical Characteristic Curve



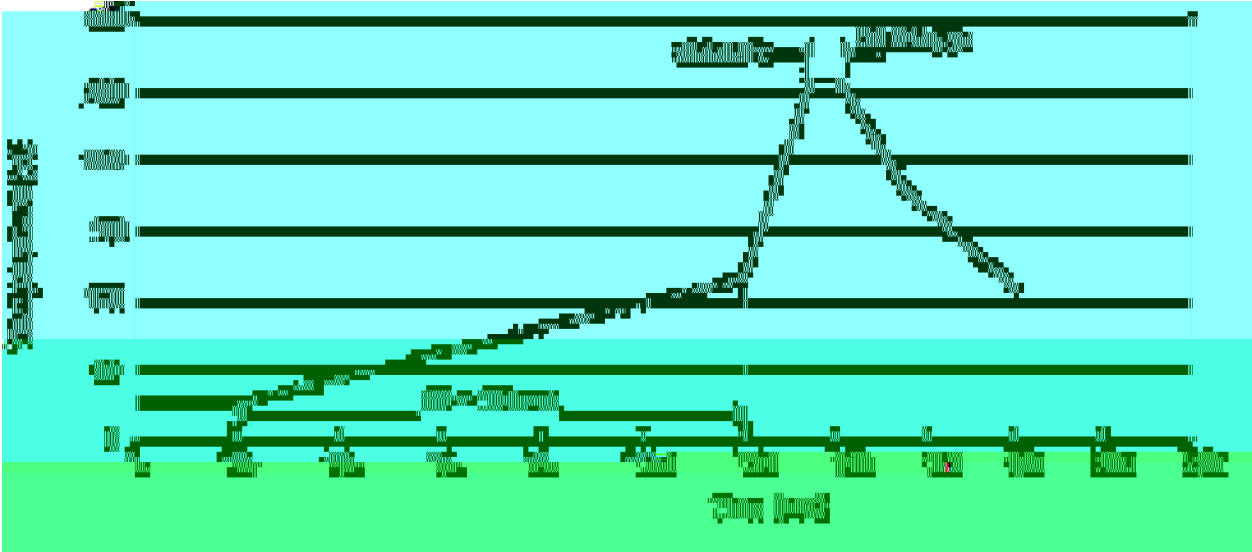
/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

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	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

/ Notices